



## PTFE/Woven Fiberglass Laminates Microwave Printed Circuit Board Substrates

### Features:

- Cross Plied Woven Fiberglass, alternating plies are oriented 90° to each other
- High PTFE to Glass Ratio
- Better dielectric constant uniformity than comparable non-woven fiberglass reinforced laminates

### Benefits:

- Electrical and Mechanical Isotropy in the X-Y Plane
- Extremely Low Loss
- Well Suited for Er Sensitive Circuits

### **Typical Applications:**

- Military Electronics (Radars, ECM, ESM)
- Microwave Components (LNAs, filters, couplers, etc.)



**CuClad®** laminates are woven fi berglass/PTFE com posite materials for use as pri nted circuit board substrates. Using precision control of the fiberglass/PTFE ratio, CuClad la minates off er a range of choi ces from the I owest di electric constant and loss tangent to a more highly reinforced laminate with better dimensional stability.

The woven fi berglass rei nforcement i n CuCl ad products provides greater dimensional stability than non-woven fiberglass re inforced PTFE bas ed laminates of similar di electric constants. The consistency and control of the PTF E coated fiberglass cloth allows Arlon to offer a greater variety of dielectric constants and produces a laminate with be tter dielectric constant uniformity than comparable non-woven fiberglass reinforced laminates. The se properties make Cu-Clad an attractive choice for filters, couplers and low noise amplifiers.

**CuClad** laminates ar e crosspli ed (alternating layers of coated fiberglass plies are oriented 90° to each other). This provides true electrical and m echanical isotropy in the XY plane, a feature uni que to CuCl ad. No other woven or nonwoven fiberglass reinforced PTFE based laminates make this cl aim. D esigners hav e found this degree of i sotropy critical in some phased array antenna applications.

**CuClad 217** (Er=2.17, 2.20) uses a low fiberglass/PTFE ratio to provide the lo west di electric constant and di ssipation factor available in fiberglass reinforced PTFE based laminates. Together, these properties offer fas ter signal propagation and higher signal/noise ratios.

**CuClad 233** (Er=2.33) uses a medi um fiberglass/PTFE ratio to balance lower dielectric constant and improved dissipation factor without sacrificing mechanical properties.

**CuClad 250** (Er=2.40–2.60) uses a higher fiberglass/PTFE ratio to prov ide mechanical properties approaching those of conventional subs trates. Better dimensional stability and lower thermal expansion in all directions are other significant benefits. The electrical properties of CuCl ad 250GT and CuClad 250GXare tested at 1MHz and 10GHz respectively. For critical performance applications, CuClad products may be specified with an "LX" testing grade; this designates that each sheet will be tested individually, and a test report will be issued with the order.

For critical performance applications, CuClad products may be specified as an "LX" testing grade; this indicates that each sheet is tested individually instead of per lot. A test report is provided with the order. "LX" designated products are higher priced, as a portion of each sheet is utilized in destructive testing.

Typical Properties: CuClad					
Property	Test Method	Condition	CuClad 217	CuClad 233	Cuclad 250
Dielectric Constant @10GHz	IPC TM-650 2.5.5.5	C23/50	2.17, 2.20	2.33	2.40 to 2.60
Dielectric Constant @1MHz	IPC TM-650 2.5.5.3	C23/50	2.17, 2.20	2.33	2.40 to 2.60
Dissipation Factor @10 GHz	IPC TM-650 2.5.5.5	C23/50	0.0009	0.0013	0.0018
Thermal Coefficient of Er (ppm/°C)	IPC TM-650 2.5.5.5 Adapted	-10°C to +140°C	-151	-171	-170
Peel Strength (lbs.per inch)	IPC TM-650 2.4.8	After Thermal Stress	14	14	14
Volume Resistivity (MΩ-cm)	IPC TM-650 2.5.17.1	C96/35/90	2.3 x 10 <sup>8</sup>	8.0 x 10 <sup>8</sup>	8.0 x 10 <sup>9</sup>
Surface Resistivity (MΩ)	IPC TM-650 2.5.17.1	C96/35/90	3.4 x 10 <sup>6</sup>	2.4 x 10 <sup>6</sup>	1.5 x 10 <sup>8</sup>
Arc Resistance (seconds)	ASTM D-495	D48/50	>180	>180	>180
Tensile Modulus (kpsi)	ASTM D-638	A, 23°C	275, 219	510, 414	725, 572
Tensile Strength (kpsi)	ASTM D-882	A, 23°C	8.8, 6.6	10.3, 9.8	26.0, 20.5
Compressive Modulus (kpsi)	ASTM D-695	A, 23°C	237	276	342
Flexural Modulus (kpsi)	ASTM D-790	A, 23°C	357	371	456
Dielectric Breakdown (kv)	ASTM D-149	D48/50	> 45	> 45	> 45
Specific Gravity (g/cm3)	ASTM D-792 Method A	A, 23°C	2.23	2.26	2.31
Water Absorption (%)	MIL-S-13949H 3.7.7 IPC TM-650 2.6.2.2	E1/105 + D24/23	0.02	0.02	0.03
Coefficient of Thermal Expansion (ppm/°C) X Axis Y Axis Z Axis Z Axis	IPC TM-650 2.4.24 Mettler 3000 Thermomechanical Analyzer	0°C to 100°C	29 28 246	23 24 194	18 19 177
Thermal Conductivity	ASTM E-1225	100°C	0.261	0.258	0.254
Outgassing Total Mass Loss (%) Collected Volatile Condensable Material (%) Water Vapor Regain (%) Visible Condensate (±)	NASA SP-R-0022A Maximum 1.00% Maximum 0.10%	125°C, ≤ 10 <sup>-6</sup> torr	0.01 0.01 0.00 NO	0.01 0.01 0.00 NO	0.01 0.00 0.00 NO
Flammability	UL 94 Vertical Burn IPC TM-650 2.3.10	C48/23/50, E24/125	Meets requirements of UL94-V0	Meets requirements of UL94-V0	Meets requirements of UL94-V0

### Material Availability:

CuClad laminates ar e supplied with 1/2, 1 or 2 oun ce electrodeposited copper on both s ides. Other copper weights and rolle d copper foil are available. CuClad is available bonded to a heavy metal ground plane. Aluminum, brass or copper plates also provide an integral heat sink and mechanical support to the substrate. When ordering CuClad products please specify dielectric constant, thickness, cladding, panel size and any other special considerations. Available master sheet sizes include 36" x 36" in a crossplied configuration and 36" x 48" in a parallel plied configuration.

Results listed above are typical properties; they are not to be used as specification limits. The above information creates no expressed or implied warranties. The properties of Arlon laminates may vary depending on the design and application.

# CuClad 217



### Figure 1

Demonstrates the Stabi lity of Dielectric Constant across Frequency. This information was correlated from data generated by using a free space and ci rcular resonator cavity. This charact eristic demonstrates the inherent robustness of Arlon Laminates across Frequency, thus simplifying the final design process when working across EM spect rum. The stabi lity of the D ielectric Constant of CuClad 217 over frequency insures easy design transition and scalability of design.



### Figure 2

Demonstrates the Sta bility of Dissipation Factor across Freque ncy. This characteristic demonstrates the inherent robustness of Arlon Lami nates across Frequency, providing as table platform for high frequency applications where signal integrity is critical to the overall performance of the application.

# CuClad 250GX



### Figure 3

Demonstrates the Stabi lity of Dielectric Constant across Frequency. This information was correlated from data generated by using a free space and ci rcular resonator cav ity. This charact eristic demonstrates t he i nherent robustness of Arlon Laminates across Fre quency, thus simplifying the final design process when working across EM spect rum. The stabi lity of the Dielectric Constant of CuClad 250GX over frequency insures easy design transition and scalability of design.



### Figure 4

Demonstrates the Sta bility of Dissipation Factor across Freque ncy. Thi s characteristic demonstrates the inherent robustness of Arlon Lami nates across Frequency, providing a stable platform for high frequency applications where signal integrity is critical to the overall performance of the application.

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